

MA3X057 (MA57)

Silicon epitaxial planar type

For band switching

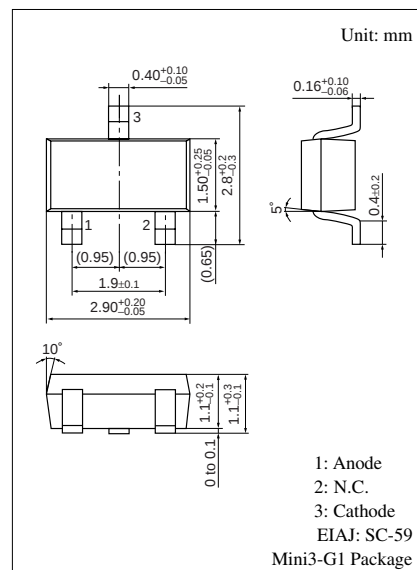
■ Features

- Low forward dynamic resistance r_f
- Less voltage dependence of diode capacity C_D
- Mini type package, allowing downsizing of equipment and automatic insertion through the taping package

■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

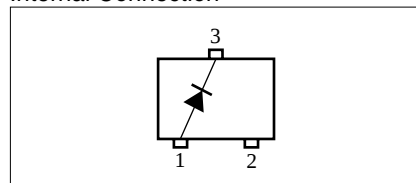
Parameter	Symbol	Rating	Unit
Reverse voltage (DC)	V_R	35	V
Forward current (DC)	I_F	100	mA
Operating ambient temperature *	T_{opr}	-25 to +85	$^\circ\text{C}$
Storage temperature	T_{stg}	-55 to +150	$^\circ\text{C}$

Note) *: Maximum ambient temperature during operation



Marking Symbol: MX

Internal Connection



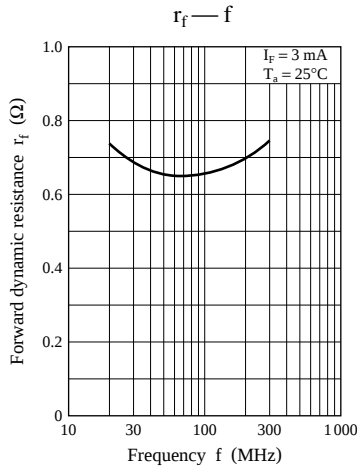
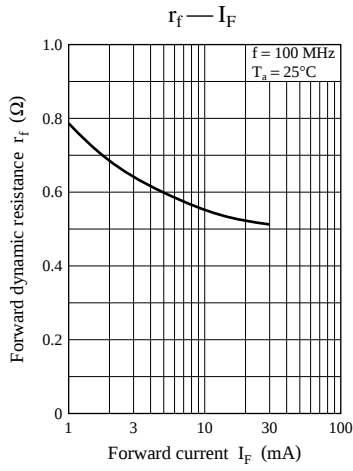
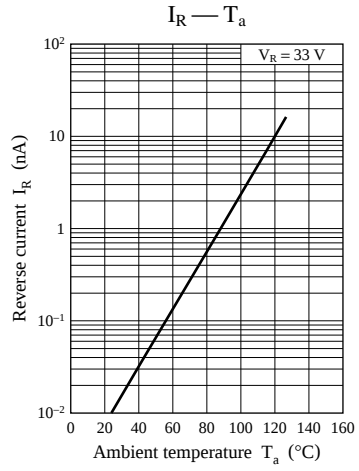
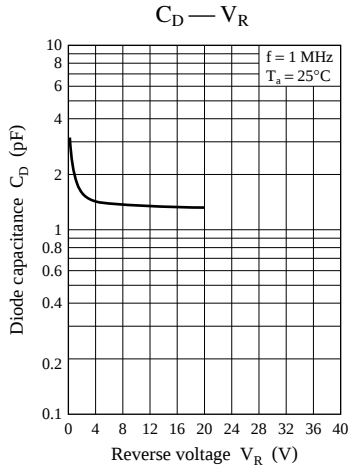
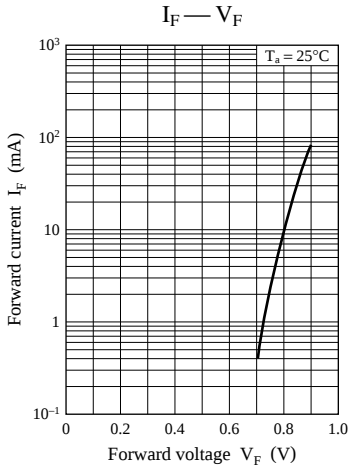
■ Electrical Characteristics $T_a = 25^\circ\text{C}$

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Reverse current (DC)	I_R	$V_R = 33\text{ V}$		0.01	100	nA
Forward voltage (DC)	V_F	$I_F = 100\text{ mA}$		0.88	1.0	V
Diode capacitance	C_D	$V_R = 15\text{ V}, f = 1\text{ MHz}$		1.3	2.0	pF
Forward dynamic resistance *	r_f	$I_F = 3\text{ mA}, f = 100\text{ MHz}$		0.78	1.15	Ω

Note) 1. Rated input/output frequency: 100 MHz

2. *: Measuring instrument; YHP MODEL 4191A RF IMPEDANCE ANALYZER

Note) The part number in the parenthesis shows conventional part number.



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